

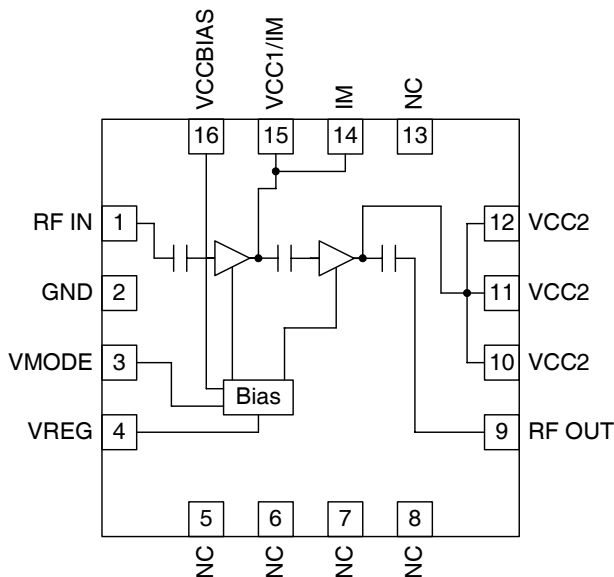


Features

- Input/Output Internally Matched@50Ω
- 28dBm Linear Output Power
- 42% Peak Linear Efficiency
- 28dB Linear Gain
- -41dBc ACLR @ ±5MHz
- HSDPA Capable

Applications

- 3V W-CDMA Band 3, 4, and 9 Handsets
- Multi-Mode W-CDMA 3G Handsets
- Spread-Spectrum Systems



Functional Block Diagram

Product Description

The RF3165 is a high-power, high-efficiency linear amplifier module specifically designed for 3V handheld systems. The device is manufactured on an advanced third generation GaAs HBT process, and was designed for use as the final RF amplifier in 3V W-CDMA handheld digital cellular equipment, spread-spectrum systems, and other applications in the 1710MHz to 1785MHz band (Band 3). The RF3165 has a digital control line for low power applications to lower quiescent current. The RF3165 is assembled in at 16-pin, 3mmx3mm, QFN package.

Ordering Information

RF3165 3V 1750MHz W-CDMA Linear Power Amplifier Module
 RF3165PCBA-410 Fully Assembled Evaluation Board

Optimum Technology Matching® Applied

- | | | | |
|--|--------------------------------------|-------------------------------------|-----------------------------------|
| <input checked="" type="checkbox"/> GaAs HBT | <input type="checkbox"/> SiGe BiCMOS | <input type="checkbox"/> GaAs pHEMT | <input type="checkbox"/> GaN HEMT |
| <input type="checkbox"/> GaAs MESFET | <input type="checkbox"/> Si BiCMOS | <input type="checkbox"/> Si CMOS | |
| <input type="checkbox"/> InGaP HBT | <input type="checkbox"/> SiGe HBT | <input type="checkbox"/> Si BJT | |

RF MICRO DEVICES®, RFMD®, Optimum Technology Matching®, Enabling Wireless Connectivity™, PowerStar®, POLARIS™ TOTAL RADIO™ and UltimateBlue™ are trademarks of RFMD, LLC. BLUETOOTH is a trademark owned by Bluetooth SIG, Inc., U.S.A. and licensed for use by RFMD. All other trade names, trademarks and registered trademarks are the property of their respective owners. ©2006, RF Micro Devices, Inc.

Absolute Maximum Ratings

Parameter	Rating	Unit
Supply Voltage (RF off)	+8.0	V
Supply Voltage ($P_{OUT} \leq 31$ dBm)	+5.2	V
Control Voltage (V_{REG})	+3.9	V
Input RF Power	+10	dBm
Mode Voltage (V_{MODE})	+3.9	V
Operating Temperature	-30 to +110	°C
Storage Temperature	-40 to +150	°C
Moisture Sensitivity Level IPC/JEDEC J-STD-20	MSL 2 @260	°C



Caution! ESD sensitive device.

Exceeding any one or a combination of the Absolute Maximum Rating conditions may cause permanent damage to the device. Extended application of Absolute Maximum Rating conditions to the device may reduce device reliability. Specified typical performance or functional operation of the device under Absolute Maximum Rating conditions is not implied.

RoHS status based on EU Directive 2002/95/EC (at time of this document revision).

The information in this publication is believed to be accurate and reliable. However, no responsibility is assumed by RF Micro Devices, Inc. ("RFMD") for its use, nor for any infringement of patents, or other rights of third parties, resulting from its use. No license is granted by implication or otherwise under any patent or patent rights of RFMD. RFMD reserves the right to change component circuitry, recommended application circuitry and specifications at any time without prior notice.

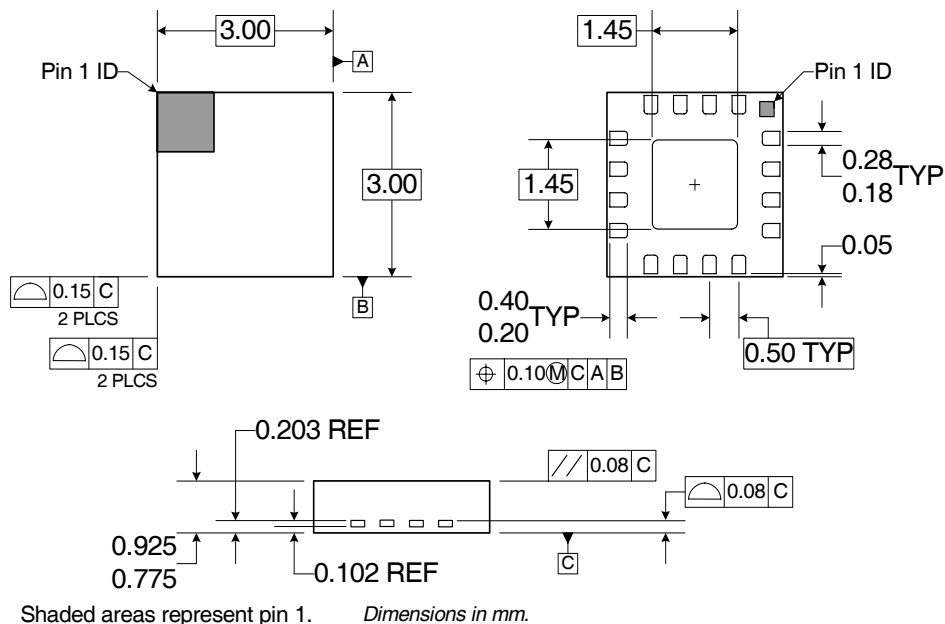
Parameter	Specification			Unit	Condition
	Min.	Typ.	Max.		
High Gain Mode (V_{MODE} Low)					T=25°C Ambient, $V_{CCBIAS}=3.4$ V, $V_{CC}=3.4$ V, $V_{REG}=2.8$ V, $V_{MODE}=0$ V, and $P_{OUT}=28$ dBm for all parameters (unless otherwise specified). Modulation is 3GPP 3.2 03-00 DPCCH + 1DPDCH.
Operating Frequency Range	1710		1785	MHz	
Linear Gain		28		dB	
Harmonics		-15		dBm	f = 2fo, 3fo
Maximum Linear Output	28			dBm	
Linear Efficiency		42		%	
Maximum I_{CC}		442		mA	
ACLR1 @ ±5 MHz		-41		dBc	
ACLR2 @ ±10 MHz		-51		dBc	
Input VSWR		2:1			
Output VSWR Stability			6:1		No oscillation > -70 dBc
			10:1		No damage
Noise Power		-146		dBm/Hz	-50 ≤ P_{OUT} ≤ +28 dBm, RX = 925 MHz to 960 MHz (Band 8)
		-115		dBm/Hz	-50 ≤ P_{OUT} ≤ +28 dBm, RX = 1805 MHz to 1880 MHz (Band 3 and 9)
		-144		dBm/Hz	-50 ≤ P_{OUT} ≤ +28 dBm, RX = 2110 MHz to 2170 MHz (Band 1 and 4)
		-151		dBm/Hz	-50 ≤ P_{OUT} ≤ +28 dBm, RX = 2400 MHz to 2480 MHz (Bluetooth)
		-156		dBm/Hz	-50 ≤ P_{OUT} ≤ +28 dBm, RX = 869 MHz to 894 MHz (Band 5 and 6)
		-140		dBm/Hz	-50 ≤ P_{OUT} ≤ +28 dBm, RX = 1930 MHz to 1990 MHz (Band 2)
IM Products					
IM 5 MHz		-41	-31	dBc	IF offset $f_0 + 5$ MHz with CW signal = -40 dBc
IM 10 MHz		-51	-41	dBc	IF offset $f_0 + 10$ MHz with CW signal = -40 dBc

Parameter	Specification			Unit	Condition
	Min.	Typ.	Max.		
Low Gain/Low V_{CC} Mode (V _{MODE} High)					T=25°C Ambient, V _{CCBIAS} =3.4V, V _{CC} =1.5V, V _{REG} =2.8V, V _{MODE} =2.8V, and P _{OUT} =16dBm for all parameters (unless otherwise specified). Modulation is 3GPP 3.2 03-00 DPCCH + 1DPDCH.
Operating Frequency Range	1710		1785	MHz	
Linear Gain		26		dB	
Maximum Linear Output				dBm	
Linear Efficiency		21.0		%	
ACLR @ ±5MHz		-40		dBc	
ACLR @ ±10MHz		-54		dBc	
Maximum I _{CC}		125		mA	
Input VSWR		2:1			
Output VSWR Stability			6:1		No oscillation > -65dBc
Ruggedness			10:1		No damage
IM Products					
IM 5MHz		-41	-31	dBc	IF offset f ₀ +5MHz with CW signal=-40dBc
IM 10MHz		-53	-41	dBc	IF offset f ₀ +10MHz with CW signal=-40dBc
Power Supply					
Supply Voltage (V _{CC1} and V _{CC2})	3.2	3.4	4.2	V	
	0.6			V	Low power with DC to DC Converter
V _{CC} Bias	1.5		4.2	V	
High Gain Idle Current (I _{CC1} /I _{CC2} /I _{CCBIAS})		70	93	mA	V _{MODE} =low and V _{REG} =2.8V, V _{CC} =3.4V
Low Gain Idle Current (I _{CC1} /I _{CC2} /I _{CCBIAS})		60	83	mA	V _{MODE} =high and V _{REG} =2.8V, V _{CC} =1.5V
V _{REG} Current		1	3	mA	
V _{MODE} Current		250		uA	
RF Turn On/Off Time		1.2	6	uS	
DC Turn On/Off Time		2	25	uS	
Total Current (Power Down)		0.2	0.5	uA	
V _{REG} Low Voltage (Power Down)	0		0.5	V	
V _{REG} High Voltage (Recommended)	2.75	2.8	2.95	V	
V _{REG} High Voltage (Operational)	2.7		3.0	V	
V _{MODE} Voltage	0		0.5	V	High Gain Mode
V _{MODE} Voltage	2.0		3.0	V	Low Gain Mode

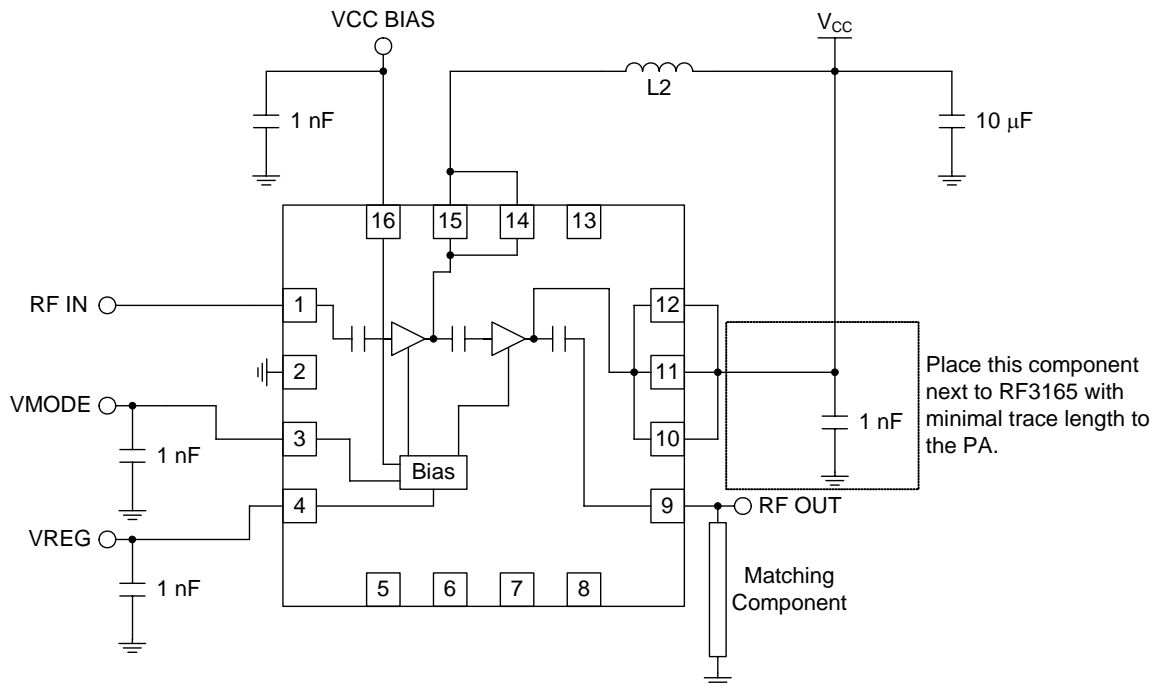
Pin	Function	Description	Interface Schematic
1	RF IN	RF input internally matched to 50Ω. This input is internally AC-coupled.	
2	GND	Ground connection.	
3	VMODE	For nominal operation (High Power mode), V _{MODE} is set LOW. When set HIGH, devices are biased lower to improve efficiency at lower output levels.	
4	VREG	Regulated voltage supply for amplifier bias circuit. In power down mode, both V _{REG} and V _{MODE} need to be LOW (<0.5V).	
5	NC	No connection. Do not connect this pin to any external circuit.	
6	NC	No connection. Do not connect this pin to any external circuit.	
7	NC	No connection. Do not connect this pin to any external circuit.	
8	NC	No connection. Do not connect this pin to any external circuit.	
9	RF OUT	RF output. Internally AC-coupled.	
10	VCC2	Output stage collector supply. Connect to pin 11 with the shortest trace possible. Please see the schematic for required external components. See note.	
11	VCC2	Output stage collector supply and output matching. Connect to pin 10 and pin 12 with the shortest trace possible. See note.	
12	VCC2	Output stage collector supply and output matching. Connect to pin 11 with the shortest trace possible. See note.	
13	NC	No connection. Do not connect this pin to any external circuit.	
14	IM	Interstage matching. Connect to pin 15 with the shortest trace possible. See note.	
15	VCC1/IM	First stage collector supply and interstage matching. A 4.7 μF decoupling capacitor may be required. Connect to pin 14 with the shortest trace possible. See note.	
16	VCCBIAS	Power supply input for the DC bias circuitry.	
Pkg Base	GND	Ground connection. The backside of the package should be soldered to a top side ground pad which is connected to the ground plane with multiple vias. The pad should have a short thermal path to the ground plane.	

Note: Refer to Layout Recommendation Application Note and Application Schematic for additional information.

Package Drawing



Application Schematic



VCC BIAS can be connected to VCC; however, VCC must be maintained above 1.5 V.

L2 = 8.2 nH and may be needed to provide isolation between VCC1 and VCC2 depending on layout.

Circuit Optimization for Various Output Power Requirements

Output Power (dBm)	Matching Component	Sample Part Number	Typical Efficiency (%)
28.5	15 nH	LQG15HN12NJ02D (Murata)	41
28	N/A		42
27.5	0.5 pF	GRM1555C1HR50BZ01E (Murata)	42

Evaluation Board Schematic

